



### **Applications**

- LTE Band 7 Uplink Infrastructure
- Base Station
- · General Purpose Wireless

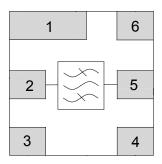


6 Pin 3x3 mm leadless SMT Package

### **Product Features**

- 70 MHz Bandwidth
- · High Attenuation
- Low Loss
- 50 Ohm Input/Output Impedance
- · Single-ended Operation
- Small Size: 3.00 x 3.00 x 1.02 mm
- Surface Mount Device
- · RoHS Compliant, Pb-Free

## **Functional Block Diagram**



Top View

## **General Description**

The TQQ7307 is a general purpose uplink BAW filter for LTE Band 7. This filter is housed in a compact 3x3 mm package for base station applications.

Low insertion loss, coupled with high attenuation makes this filter an ideal choice for uplink RF filtering needs.

The TQQ7307 is part of TriQuint's extensive portfolio of RF BAW and SAW filters.

# **Pin Configuration**

Pin No.	Label
2	Input
5	Output
1,3,4,6	Case Ground

# **Ordering Information**

Part No.	Description			
TQQ7307	2535 MHz BAW Filter			
TQQ7307-EVB	Evaluation board			
0, 1, 17,0 ; 0,500 ; 71, 1				

Standard T/R size = 2500 pieces on a 7" reel



# 2535 MHz LTE Band 7 Uplink BAW Filter

### **Absolute Maximum Ratings**

Parameter	Rating
Storage Temperature	−40 to +95°C
RF Input Power	
(CW, +55°C for 10,000 hours)	+30 dBm

Operation of this device outside the parameter ranges given above may cause permanent damage.

### **Recommended Operating Conditions**

Parameter	Min	Тур	Max	Units
T <sub>CASE</sub>	-40		+85	°C

Electrical specifications are measured at specified test conditions.

# Electrical Specifications (1,2,3,4)

Test conditions unless otherwise specified: Passband Freq.=2500-2570 MHz, Temp. Range=-40 to +85°C, Z<sub>S</sub>=Z<sub>I</sub>=50 Ohms

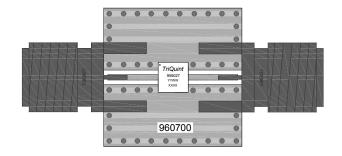
Parameter	Conditions	Min	Typ <sup>(4)</sup>	Max	Units
Center Frequency		-	2535	_	MHz
3.5 dB Bandwidth		-	83	-	MHz
Maximum Insertion Loss		-	2.0	3.5	dB
Amplitude Variation <sup>(5)</sup>		-	0.9	2.4	dB
Group Delay Variation <sup>(6)</sup>		-	14	30	ns p-p
Group Delay Variation <sup>(6)</sup>	Any 5 MHz band in passband	-	7	13	ns p-p
Input VSWR	2500 – 2570 MHz	-	1.9:1	2.4:1	-
Output VSWR	2500 – 2570 MHz		1.8:1	2.4:1	-
Stopband Attenuation (relative to zero dB)	0.9 – 1100 MHz 1100 – 2170 MHz 2170 – 2260 MHz 2260 – 2450 MHz 2450 – 2480 MHz 2590 – 2620 MHz 2620 – 2690 MHz 2690 – 2900 MHz 2900 – 3800 MHz 3800 – 5000 MHz 5000 – 6000 MHz	36 30 38 32 12 8 40 40 30 13	40 34 45 39 20 12 48 47 37 17	- - - - - - -	dB
Source/Load Impedance (7)	Single ended	-	50	-	Ohms

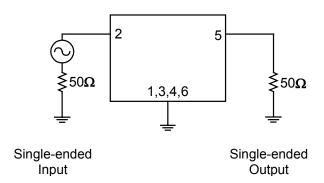
#### Notes:

- 1. All specifications are based on the TriQuint schematic for the main reference design.
- 2. Production test is performed at room temp. to a guard-banded specification to ensure electrical compliance over temperature.
- 3. Electrical margin has been built into the design to account for variation due to temperature drift and manufacturing tolerances.
- 4. Typical values are based on average measurements at room temperature of 25°C.
- 5. This is defined as the difference between the maximum and minimum insertion loss within the specified band.
- 6. This is defined as the worst case difference between a peak and adjacent valley within defined frequency points.
- 7. This is the optimum impedance in order to achieve the performance shown.



### **TQQ7307-PCB Evaluation Board**





## **Bill of Material - TQQ7307-PCB**

Reference Des.	Value	Description	Manuf.	Part Number
U1	n/a	2535 MHz BAW Filter	TriQuint	TQQ7307
n/a	n/a	Printed Circuit Board	TriQuint	960700
n/a	n/a	SMA Edge Connector	Radiall	9602-1111-018

### **Evaluation Board PCB Information**

Top, middle & bottom layers: 1 oz copper Substrates: FR4 dielectric, .031" thick

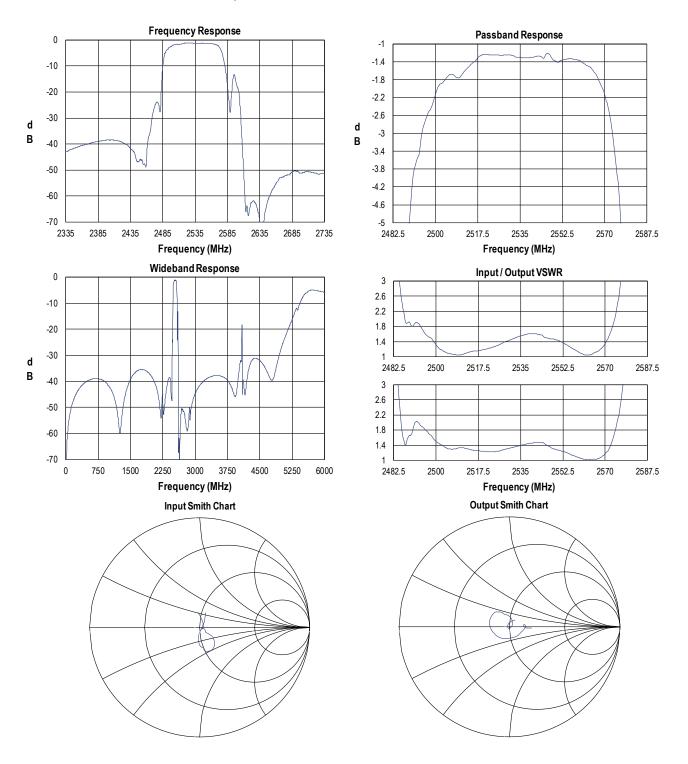
Finish plating: Nickel: 3-8µm thick, Gold: .03-.2µm thick

Hole plating: Copper min .0008µm thick



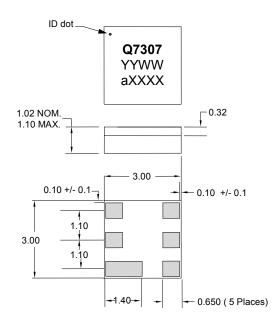
# **Performance Plots**

Test conditions unless otherwise noted: Temp= +25°C





### Package Material, Marking and Dimensions



Package Style: 6-pin 3x3 leadless SMT Dimensions: 3.00 x 3.00 x 1.02 mm

4 layer laminate based over-molded module

Contact plating : ENIG (Electroless Nickel Immersion Gold) Terminations: *Au* plating 0.5 - 1.0µm, over a 2-6µm *Ni* 

plating

All dimensions shown are nominal in millimeters All tolerances are  $\pm 0.15$ mm except overall length and width  $\pm 0.10$ mm

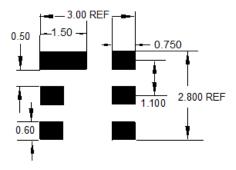
Package Marking:

Part Number: Q7307 Year/Week: YYWW Assembly Code: aXXXX

### **PCB Mounting Pattern**

#### Notes:

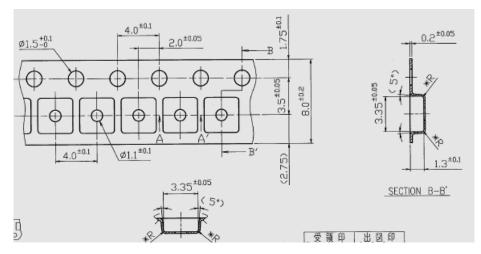
- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. Use 1 oz. copper minimum for top and bottom layer metal.



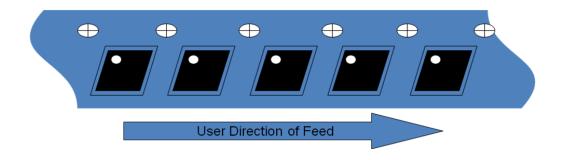


# Tape and Reel Information – Carrier and Cover Tape Dimensions

Tape and reel specifications for this part are also available on the TriQuint website. Standard T/R size = 2500 pieces on a 7" reel.



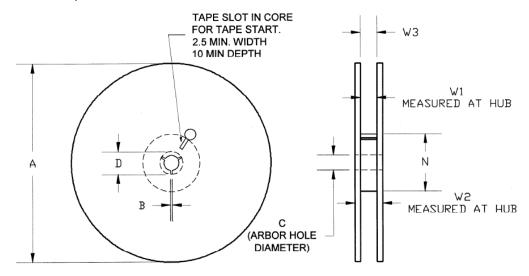
Feature	Measure	Symbol	Size (in)	Size (mm)
Cavity	Length	A0	0.132	3.35
	Width	В0	0.132	3.35
	Depth	K0	0.055	1.40
	Pitch	P1	0.157	4.00
Centerline	Cavity to Perforation - Length Direction	P2	0.079	2.00
Distance	Cavity to Perforation - Width Direction	F	0.138	3.50
Cover Tape	Width	С	0.213	5.40
Carrier Tape	Width	W	0.315	8.00



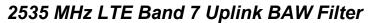


# **Tape and Reel Information – Reel Dimensions**

Tape and reel specifications for this part are also available on the TriQuint website. Standard T/R size = 2,500 pieces on a 7" reel.



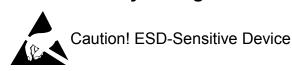
Feature	Measure	Symbol	Size (in)	Size (mm)
Flange	Diameter	Α	6.969	177.0
	Thickness	W2	0.559	14.2
	Space Between Flange	W1	0.346	8.8
Hub	Outer Diameter	N	2.283	58.0
	Arbor Hole Diameter	С	0.512	13.0
	Key Slit Width	В	0.079	2.0
	Key Slit Diameter	D	0.787	20.0





### **Product Compliance Information**

### **ESD Sensitivity Ratings**



ESD Rating: Class 1B

Value: Passes ≥ 500V to < 1000V
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

ESD Rating: Class B

Value: Passes ≥ 200V to < 400V Test: Machine Model (MM)

Standard: JEDEC Standard JESD22-A115

### **MSL Rating**

MSL Rating: Level 3

Test: 260°C convection reflow

Standard: JEDEC Standard IPC/JEDEC J-STD-020

### **Solderability**

Compatible with both lead-free (260°C maximum reflow temperature) and tin/lead (245°C maximum reflow temperature) soldering processes.

Contact plating: ENIG (Electroless Nickel Immersion Gold)

### **RoHs Compliance**

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free
- SVHC Free

#### **Contact Information**

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